



() Preliminary Specification (V) Final Specification

Module	14.0" (13.97") HD 16:9 Color TFT-LCD with LED Backlight design	
Model Name	B140XW02 V1 (3A)	
Note (🗭)	LED Backlight with driving circuit design	20)

Customer	Date
<u>Sony</u>	
Checked & Approved by	Date
Note: This Specification without notice.	is subject to change

Approved by	Date			
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Contents

1.	Handling Precautions	4
2.	General Description	5
	2.1 General Specification.	5
	2.2 Optical Characteristics	
3.	Functional Block Diagram	11
4.	Absolute Maximum Ratings	12
	4.1 Absolute Ratings of TFT LCD Module	12
	4.2 Absolute Ratings of Environment.	
5.	Electrical Characteristics	13
	5.1 TFT LCD Module	13
	5.2 Backlight Unit	
6.	Signal Interface Characteristic	16
	6.1 Pixel Format Image	16
	6.2 The Input Data Format	17
	6.3 Integration Interface Requirement	18
	6.4 Interface Timing	
7.	Panel Reliability Test	23
	7.1 Vibration Test	23
	7.2 Shock Test	23
	7.3 Reliability Test	23
8.	Mechanical Characteristics	24
	8.1 LCM Outline Dimension	24
9.	Shipping and Package	26
	9.1 Shipping Label Format	26
	9.2 Carton Package	27
	9.3 Shipping Package of Palletizing Sequence	27
10	D. Appendix: EDID Description	28





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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electronic breakdown.





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2. General Description

B140XW02 V1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B140XW02 V1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

Items	Unit	Specifications					
Screen Diagonal	[mm]	354, 14.0"(13.97")				
Active Area	[mm]	309.399 x 173.952					
Pixels H x V		1366 x 3(R	GB) x 768				
Pixel Pitch	[mm]	0.2265 x 0.	2265				
Pixel Format	0	B.G.R. Ver	tical Stripe				
Display Mode		Normally W	/hite				
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]	200 typ. (5 points average) 170 min. (5 points average)					
Luminance Uniformity		1.25 max. (5 points)				
Contrast Ratio		500 typ					
Response Time	[ms]	8 typ / 16 N	<i>l</i> ax				
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	4.5 max. (Ir	nclude Logic	and Blu pov	wer)		
Weight	[Grams]	320 max.					
			Min.	Тур.	Max.		
Physical Size	[mm]	Length	319.9	320.4	320.9		
Include bracket	[]	Width	204.6	205.1	205.6		
		Thickness 3.6					
Electrical Interface		1 channel LVDS					
Glass Thickness	[mm]	0.5					
Surface Treatment		Glare, Hard Reflection	,				

B140XW02 V1 Document Version: 1.0

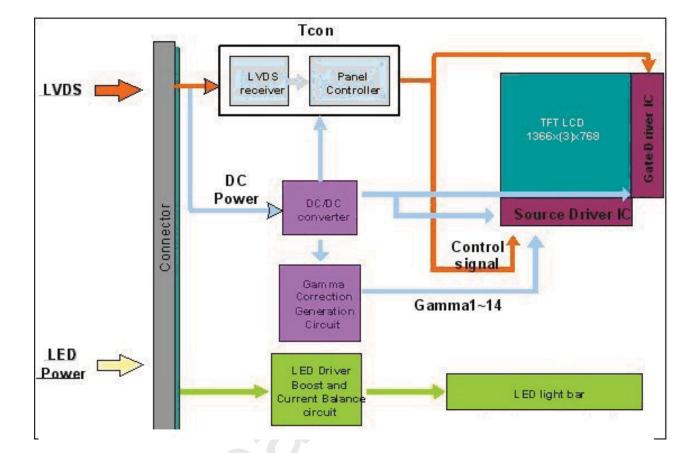




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3. Functional Block Diagram

The following diagram shows the functional block of the 14.0 inches wide Color TFT/LCD 40 Pin one channel Module



B140XW02 V1 Document Version: 1.0





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

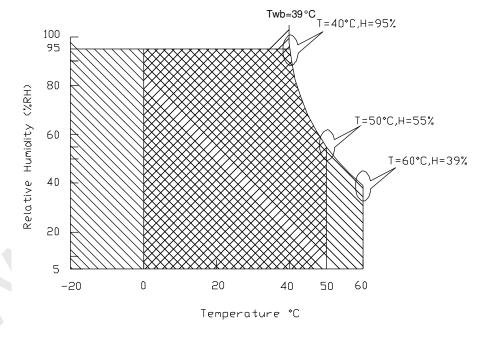
III / NOCOIGIO I IGIII	12 / 1550 late Hatings of Environment								
ltem	Symbol	Min	Max	Unit	Conditions				
Operating Temperature	TOP	0	+50	[°C]	Note 4				
Operation Humidity	HOP	5	95	[%RH]	Note 4				
Storage Temperature	TST	-20	+60	[°C]	Note 4				
Storage Humidity	HST	5	95	[%RH]	Note 4				

Note 1: At Ta (25℃)

Note 2: Permanent damage to the device may occur if exceed maximum values

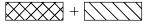
Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range





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5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

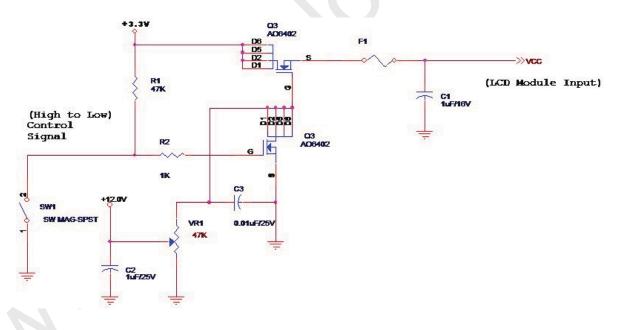
Input power specifications are as follows;

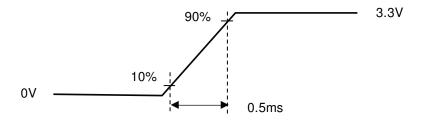
The power specification are measured under 25℃ and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	ı	1	[Watt]	Note 1
IDD	IDD Current	-	ı	333	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{black})

Note 2: Measure Condition





Vin rising time





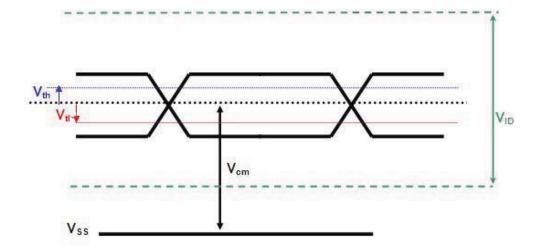
5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{th}	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
V _{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V_{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform







5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	3.5	[Watt]	(Ta=25°€), Note 1 Vin =12V
LED Life-Time	N/A	12,000	-	-	Hour	(Ta=25°€), Note 2 I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	7.0	12.0	21.0	[Volt]	
LED Enable Input High Level		2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level		2.5	-	5.5	[Volt]	Connector
PWM Logic Input Low Level	VPWM_EN	-	-	0.8	[Volt]	(Ta=25°€)
PWM Input Frequency	FPWM	100	-	20K	Hz	
PWM Duty Ratio	Duty	5		100	%	





6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format. $\label{eq:local_policy}$

	1				1366
1st Line	R G B	RGB		R G E	B R G B
	ı		1	-	1
			•		1 . 1
	'	'	'	'	1 ' 1
		٠.	•		1 . 1
	'		•		1 . 1
	'		•		1 . 1
	'	'	•		'
			•		1 . 1
	'	;	;	:	;
	'.	'	<u> </u>	;	
	;		· ·		
	·	'	·	•	'
768 th Line√	R G B	RGB		R G E	B R G B

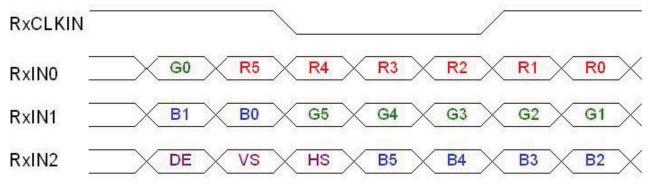
B140XW02 V1 <u>Document Version : 1.0</u> 16 of 30





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6.2 The Input Data Format



	T	
Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	, ,	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	~
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
		DE signals. All pixel data shall be valid at the
		falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.





6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector		
Manufacturer	IPEX or compatible		
Type / Part Number	IPEX 20455-040E-12A or compatible		
Mating Housing/Part Number	IPEX 20453-040T-11 or compatible		

6.3.2 Pin Assignment

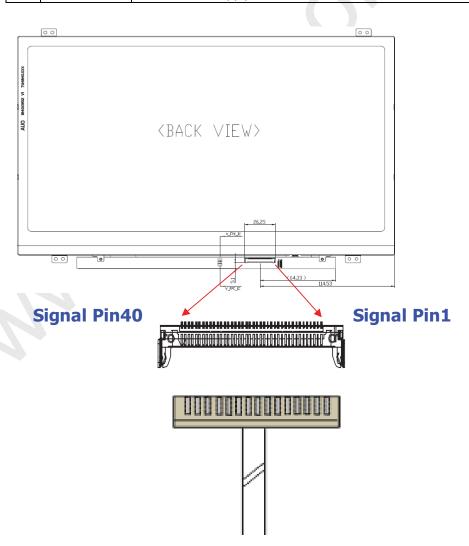
LVDS is a differential signal technology for LCD interface and high speed data transfer device

litial Si	B140XW02 V1				
Pin	Signal	Description			
1	NC	No Connection (Reserve)			
2	VDD	PowerSupply,3.3V(typical)			
3	VDD	PowerSupply,3.3V(typical)			
4	DVDD	DDC 3.3Vpower			
5	NC	No Connection (Reserve)			
6	SCL	DDC Clock			
7	SDA	DDC Data			
8	Rin0-	-LVDS differential data input(R0-R5,G0)			
9	Rin0+	+LVDS differential data input(R0-R5,G0)			
10	GND	Ground			
11	Rin1-	-LVDS differential data input(G1-G5,B0-B1)			
12	Rin1+	+LVDS differential data input(G1-G5,B0-B1)			
13	GND	Ground			
14	Rin2-	-LVDS differential data input(B2-B5,HS,VS,DE)			
15	Rin2+	+LVDS differential data input(B2-B5,HS,VS,DE)			
16	GND	Ground			
17	ClkIN-	-LVDS differential clock input			
18	ClkIN+	+LVDS differential clock input			
19	GND	Ground			
20	NC	No Connection (Reserve)			
21	NC	No Connection (Reserve)			
22	GND	Ground			
23	NC	C No Connection (Reserve)			





24	NC	No Connection (Reserve)		
25	GND	Ground-Shield		
26	NC	No Connection (Reserve)		
27	NC	No Connection (Reserve)		
28	GND	Ground-Shield		
29	NC	No Connection (Reserve)		
30	NC	No Connection (Reserve)		
31	VLED_GND	LED Ground		
32	VLED_GND	LED Ground		
33	VLED_GND	LED Ground		
34	NC	No Connection (Reserve)		
35	PWM	System PWM Signal Input		
36	LED_EN	LED enable pin(+3V Input)		
37	NC	NC for DCR Enable only		
38	VLED	LED Power Supply 7V-21V		
39	VLED	LED Power Supply 7V-21V		
40	VLED	LED Power Supply 7V-21V		



Note1: Input signals shall be low or High-impedance state when VDD is off.





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6.4 Interface Timing

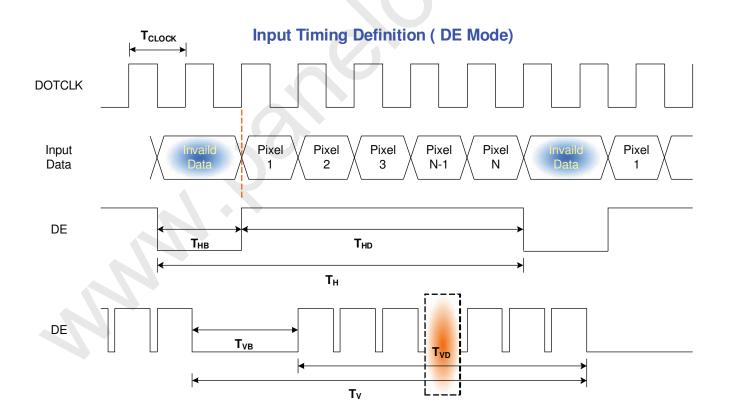
6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T _{Clock}	•	72	•	MHz
Vertical Section	Period	T _V	780	803	1023	
	Active	T _{VD}	768			T _{Line}
	Blanking	T _{VB}	12	35	255	
	Period	T _H	1406	1494	2047	
Horizontal Section	Active	T _{HD}	1366			T _{Clock}
	Blanking	T HB	40	128	681	

Note : DE mode only

6.4.2 Timing diagram





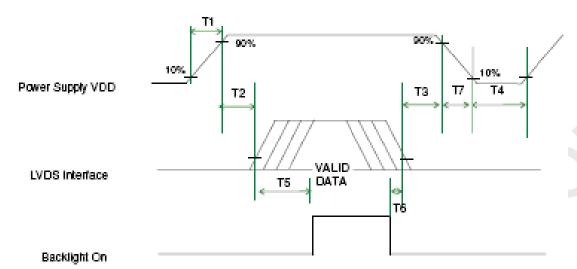
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6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing

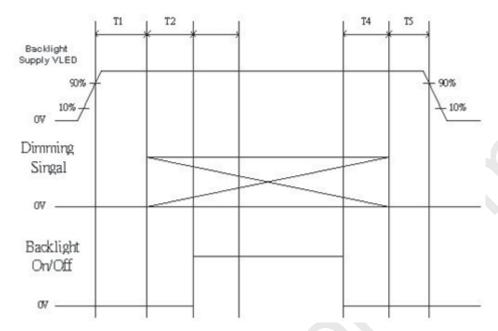
Parameter	Min.	Typ.	Max.	Units
T1	0.5		10	
T2	0	-	50	
Т3	0	_	50	
T4	400			ms
		-	-	
T5	200	-	-	
Т6	200	-	-	
Т7	0		10	

Note:If T3,T5,T6 couldn't match above specifications, must request T3+T5+T6 > 200ms at least





LED on/off sequence is as follows. Interface signals are also shown in the chart.



Symbol	Min	Тур	Max	Unit
T1	10			
T2	10			
T4	0			ms
Т5	10			

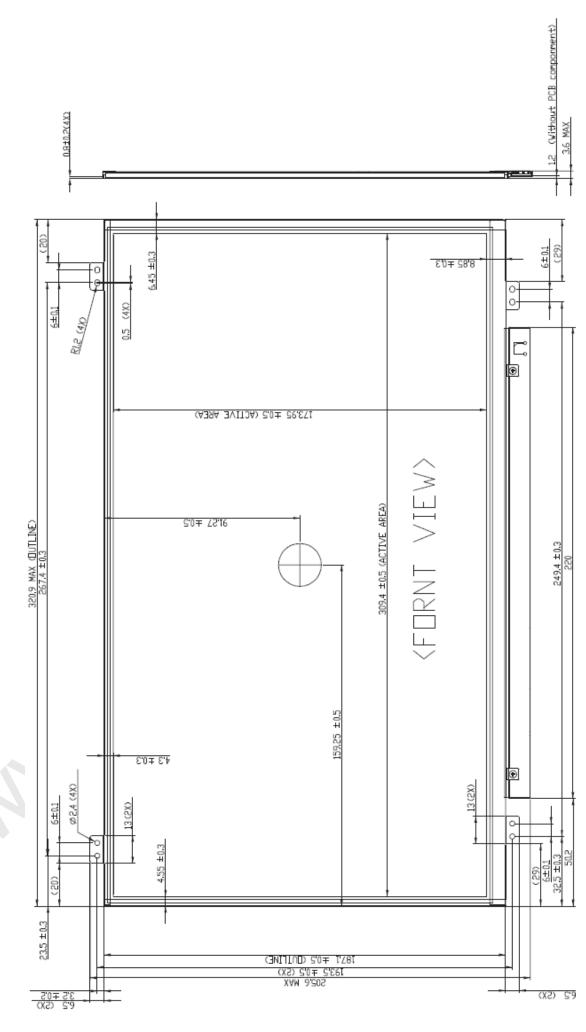
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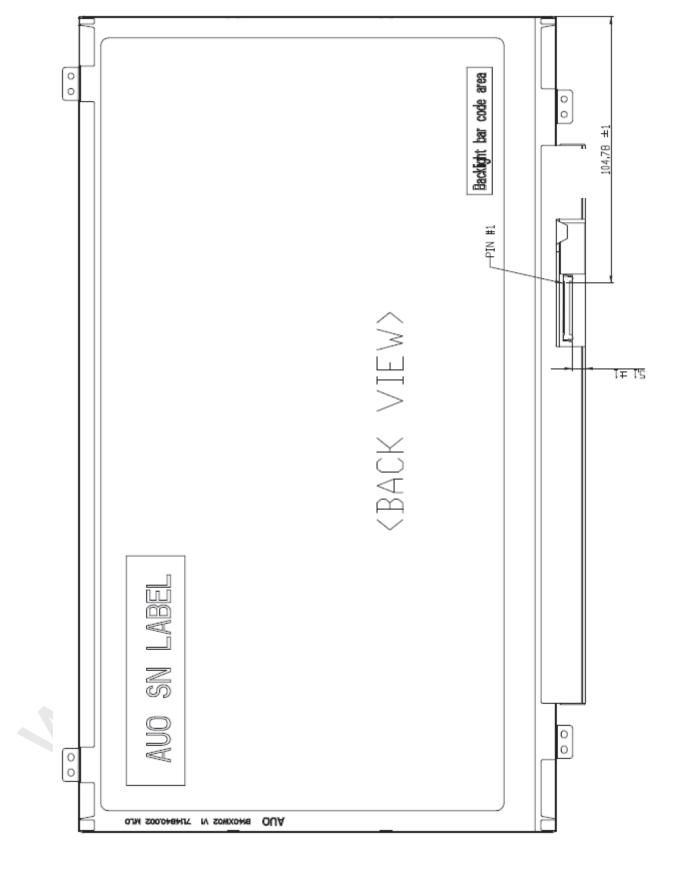
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8. Mechanical Characteristics 8.1 LCM Outline Dimension



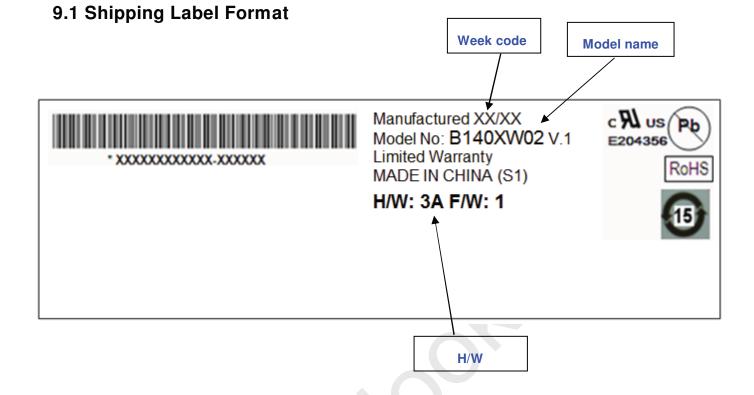
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Note: Prevention IC damage, IC positions not allowed any overlap over these areas. B140XW02 V1 Document Version: 1.0



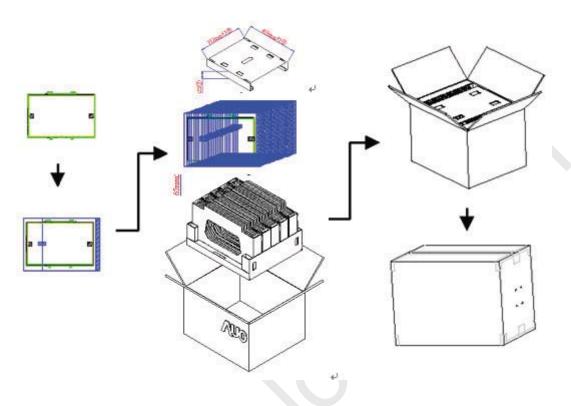
9. Shipping and Package





9.2 Carton Package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



9.3 Shipping Package of Palletizing Sequence

